

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-30V	3.4m Ω @-10V	-100A
	4.8m Ω @-4.5V	

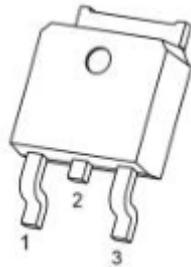
Feature

- High switching speed
- Low Gate Charge
- High density cell design for ultra low Rdson
- 100% Single Pulse avalanche energy Test

Application

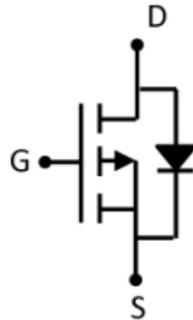
- Load Switching
- DC-DC

Package



TO-252(1:G 2:D 3:S)

Circuit diagram



Marking



30P03 =Device Code
****** =Week Code

Absolute maximum ratings

($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous($T_C=25^{\circ}\text{C}$)	I_D	-100	A
Pulsed Drain Current	I_{DM}	-400	A
Single Pulse Avalanche Energy ²	E_{AS}	306	mJ
Maximum Power Dissipation($T_C=25^{\circ}\text{C}$)	P_D	89	W
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	1.4	$^{\circ}\text{C}/\text{W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^{\circ}\text{C}$

Electrical characteristics

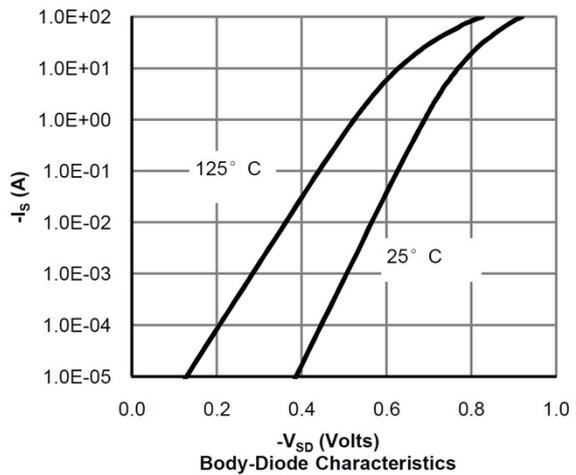
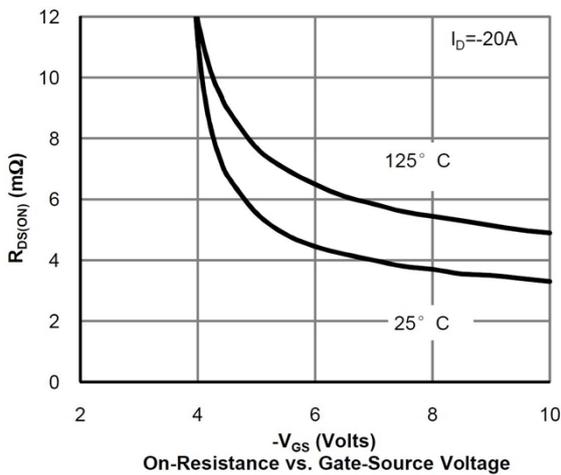
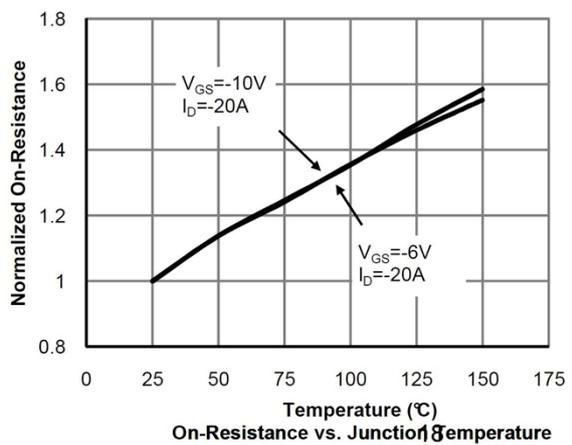
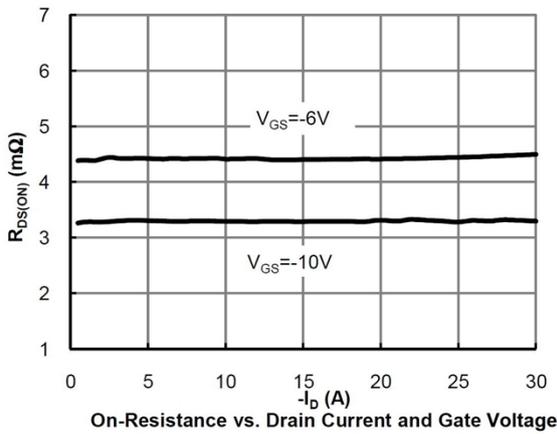
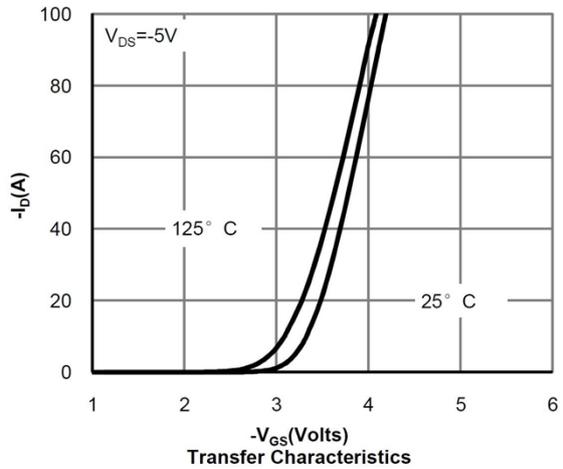
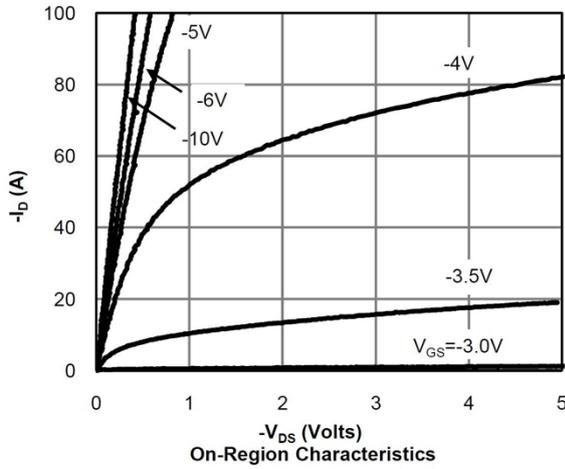
($T_A=25^{\circ}\text{C}$, unless otherwise noted)

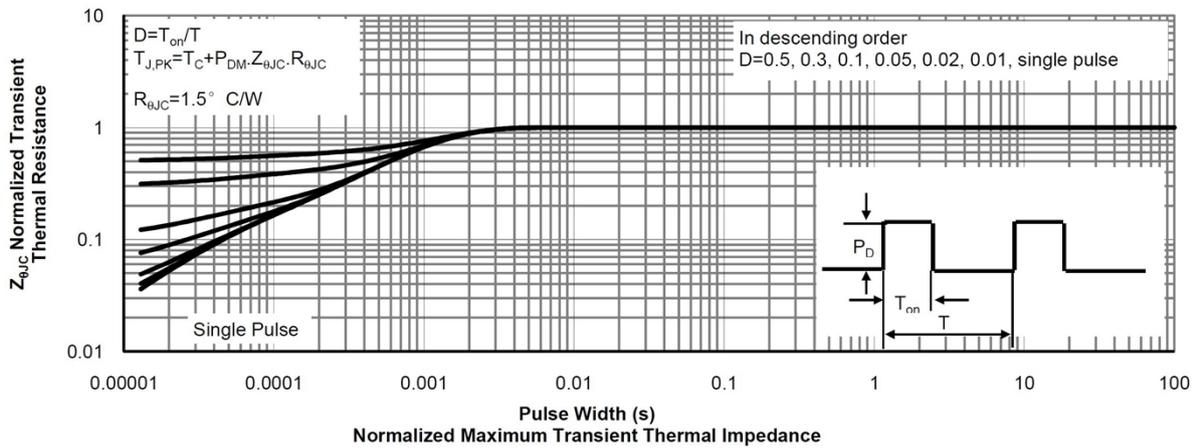
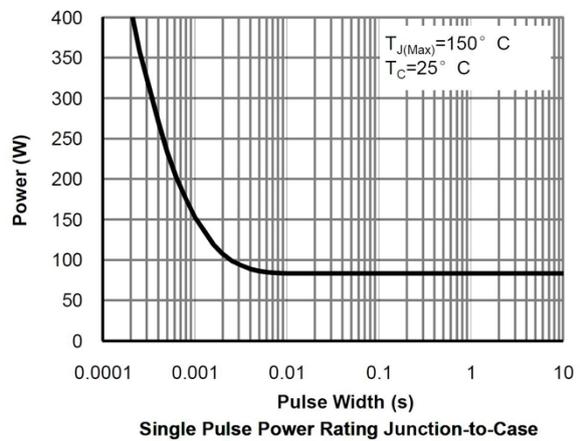
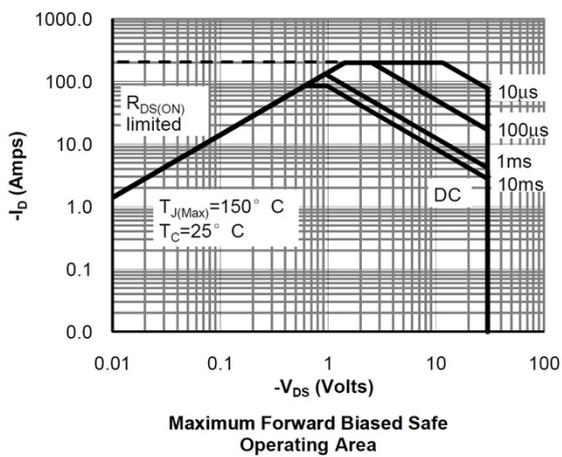
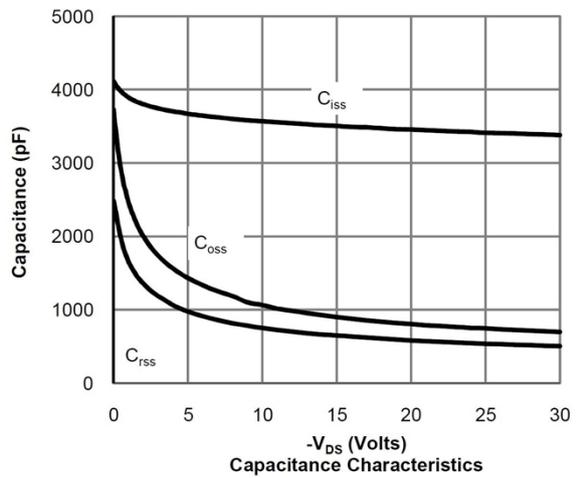
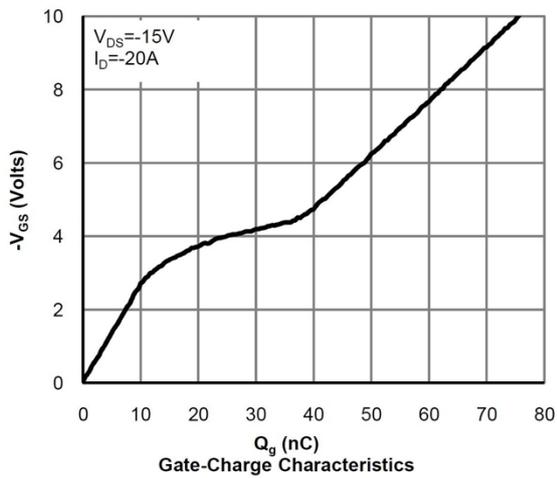
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV (BR) _{DSS}	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$			-1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			± 100	μA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1	-1.6	-2.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -10\text{V}, I_D = -30\text{A}$		3.4	4.3	m Ω
		$V_{GS} = -4.5\text{V}, I_D = -20\text{A}$		4.8	6.4	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = -15\text{V}, V_{GS} = 0\text{V},$ $f = 1\text{MHz}$		5700		pF
Output Capacitance	C_{oss}			859		
Reverse Transfer Capacitance	C_{rss}			650		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DD} = -15\text{V}, I_D = 20\text{A},$ $V_{GS} = -10\text{V}$		75		nC
Gate-Source Charge	Q_{gs}			13		
Gate-Drain Charge	Q_{gd}			23		
Turn-on Delay Time	$T_{d(on)}$	$V_{DD} = -15\text{V}, R_L = 0.75\Omega,$ $V_{GEN} = -10\text{V}, R_{GEN} = 3\Omega$		14		nS
Turn-on Rise Time	T_r			16		
Turn-off Delay Time	$T_{d(off)}$			94		
Turn-off Fall Time	T_f			75		
Drain-Source Diode Characteristics						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = -1\text{A}$			-1	V

Note:

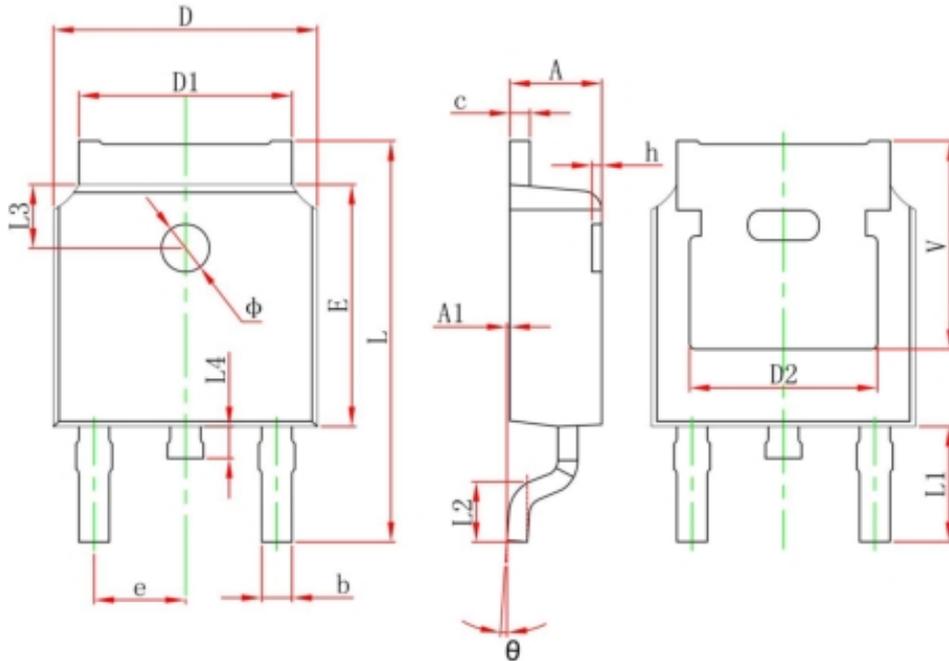
- The E_{AS} data shows Max. rating . The test condition is $V_{DD} = -15\text{V}, V_{GS} = -10\text{V}, L = 0.5\text{mH}, R_g = 25\Omega$

Typical Characteristics





TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	